MOSFET – Power, Single, N-Channel, DPAK 40 V, 38 A

Features

- Low R_{DS(on)}
- High Current Capability
- Low Gate Charge
- STD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Electronic Brake Systems
- Electronic Power Steering
- Bridge Circuits

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

$\begin{tabular}{ c c c } \hline Parameter \\ \hline \hline Drain-to-Source Voltage \\ \hline \hline Gate-to-Source Voltage \\ \hline \hline Gate-to-Source Voltage \\ \hline \hline Continuous Drain \\ Current - R_{\theta JC} \\ \hline \hline T_C = 25^\circ C \\ \hline \hline T_C = 100^\circ C \\ \hline \hline T_C = 25^\circ C \\ \hline \hline T_C = 25^\bullet C \\ \hline T_C = 25^\bullet$	Symbol V _{DSS} V _{GS} I _D P _D	Value 40 ±20 38 27 75	Unit V V A
$\begin{tabular}{ c c c c c } \hline Gate-to-Source Voltage & \hline & \\ \hline Continuous Drain \\ Current - R_{\theta JC} & \hline & \\ \hline Steady \\ State & \hline & \\ \hline T_C = 25^\circ C \\ \hline & \\ \hline T_C = 100^\circ C \\ \hline & \\ \hline \hline & \\ \hline \hline & \\ \hline & \\ \hline \hline & \\ \hline \hline & \\ \hline \hline & \\ \hline & \\ \hline \hline & \hline \hline \\ \hline \hline \\ \hline \hline \\ \hline \hline \hline \\ \hline \hline \hline \hline$	V _{GS} I _D	±20 38 27	V A
$ \begin{array}{c} \mbox{Continuous Drain} \\ \mbox{Current} - R_{\theta JC} \end{array} & \begin{array}{c} \mbox{Steady} \\ \mbox{State} \end{array} & \begin{array}{c} T_C = 25^\circ C \\ \hline T_C = 100^\circ C \\ \end{array} \\ \hline \mbox{Power Dissipation} - \\ \hline \mbox{Steady} \\ \hline \mbox{State} \end{array} & \begin{array}{c} T_C = 25^\circ C \\ \hline \mbox{T}_C = 25^\circ C \\ \hline \mbox{State} \end{array} \\ \hline \end{array} $	Ι _D	38 27	A
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$		27	
State $T_C = 100^{\circ}C$ Power Dissipation -Steady $R_{\theta JC}$ $T_C = 25^{\circ}C$	PD		
R _{0JC} State	P _D	75	
Continuous Drain Steady T ₄ = 25°C			W
	ID	7.6	А
Current $R_{\theta JA}$ (Note 1) State $T_A = 100^{\circ}C$		5.3	
$\begin{array}{c c} \mbox{Power Dissipation} - & \mbox{Steady} \\ \mbox{R}_{\theta JA} \mbox{ (Note 1)} & \mbox{State} \end{array} T_A = 25^{\circ} C$	P _D	2.9	W
Pulsed Drain Current $t_p = 10 \ \mu s$	I _{DM}	75	А
Operating Junction and Storage Temperature	T _J , T _{STG}	–55 to 175	°C
Source Current (Body Diode)	۱ _S	36	А
Single Pulse Drain-to Source Avalanche Energy – (V _{DD} = 50 V, V _{GS} = 10 V, I _{PK} = 17 A, L = 1 mH, R _G = 25 Ω)	EAS	150	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	ΤL	260	°C

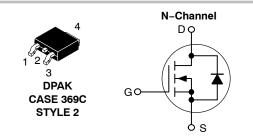
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



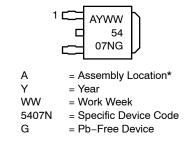
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V _{(BR)DSS}	R _{DS(ON)} TYP	I <mark>D MAX</mark> (Note 1)		
40 V	21 mΩ @ 10 V	38 A		



MARKING DIAGRAM



* The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

ORDERING INFORMATION

Device	Package	Shipping†
NTD5407NT4G	DPAK (Pb–Free)	2500 / Tape & Reel
STD5407NT4G*	DPAK (Pb–Free)	2500 / Tape & Reel
NVD5407NT4G*	DPAK (Pb–Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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THERMAL RESISTANCE RATINGS (Note 1)

Parameter	Symbol	Max	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	2.0	°C/W
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	52	°C/W

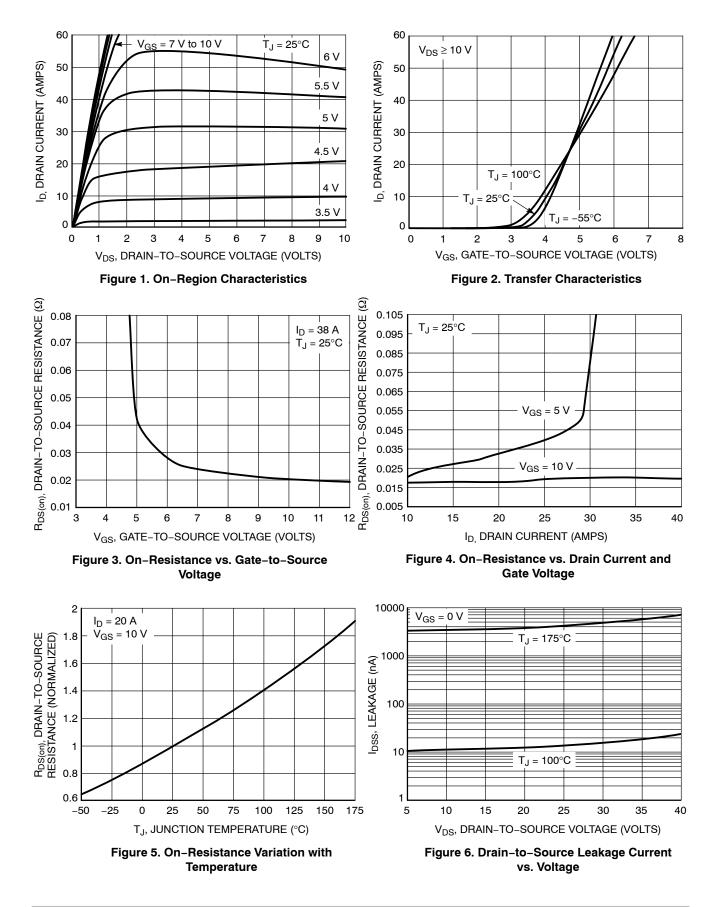
1. Surface mounted on FR4 board using 1 sq in pad size, (Cu Area 1.127 sq in [2 oz] including traces).

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

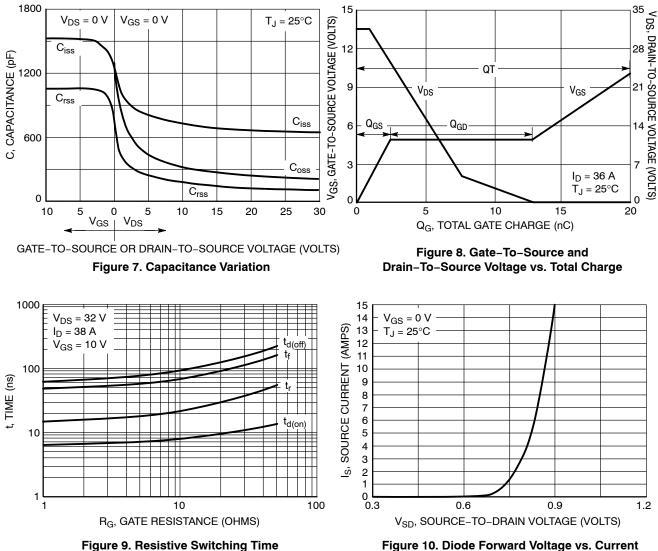
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	· · · · · · · · · · · · · · · · · · ·				-	-	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_{D} = 250 μA		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				39		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1.0	μΑ
		V _{DS} = 40 V	$T_J = 100^{\circ}C$			10	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±30 V				±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{DS}$) = 250 μA	1.5		3.5	V
Gate Threshold Temperature Coefficient	$V_{GS(TH)}/T_J$				-6.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V,	I _D = 20 A		21	26	mΩ
		V _{GS} = 5.0 V, I _D = 10 A			32	40	
Forward Transconductance	g fs	V _{GS} = 10 V, I _D = 18 A			15		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}				615	1000	pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = V _{DS} = 3	1.0 MHz, 82 V		173		
Reverse Transfer Capacitance	C _{RSS}	• D3 = 3			80		
Total Gate Charge	Q _{G(TOT)}				20		nC
Gate-to-Source Charge	Q _{GS}	$V_{GS} = 10 \text{ V}, \text{ V}_{DS} = 32 \text{ V},$ $I_D = 38 \text{ A}$			2.25		
Gate-to-Drain Charge	Q _{GD}			10.5			
SWITCHING CHARACTERISTICS, Vo	is = 10 V (Note :	3)					
Turn-On Delay Time	t _{d(ON)}				6.8		ns
Rise Time	t _r	V _{GS} = 10 V, V	חם = 32 V,		17		
Turn-Off Delay Time	t _{d(OFF)}	V _{GS} = 10 V, V I _D = 38 A, R ₀	_G = 2.5 Ω		66		
Fall Time	t _f		Γ		51		
SWITCHING CHARACTERISTICS, Vo	is = 5 V (Note 3))					
Turn-On Delay Time	t _{d(ON)}				10		ns
Rise Time	t _r	V _{GS} = 5 V, V _E	n = 20 V,		175		
Turn-Off Delay Time	t _{d(OFF)}	$I_{\rm D} = 20 \text{ A}, R_{\rm G} = 2.5 \Omega$			13		1
Fall Time	t _f				23		
DRAIN-SOURCE DIODE CHARACTE	RISTICS (Note	2)					
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 5.0 A	$T_J = 25^{\circ}C$		0.9	1.1	V
			$T_J = 125^{\circ}C$		0.75		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/μs, I _S = 15 A			38		ns
Charge Time	ta				20.5		
Discharge Time	t _b				17		
Reverse Recovery Charge	Q _{RR}				40		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%. 3. Switching characteristics are independent of operating junction temperatures.

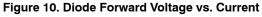
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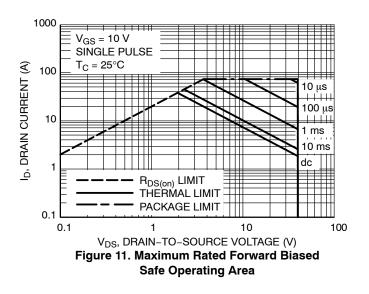


TYPICAL PERFORMANCE CURVES

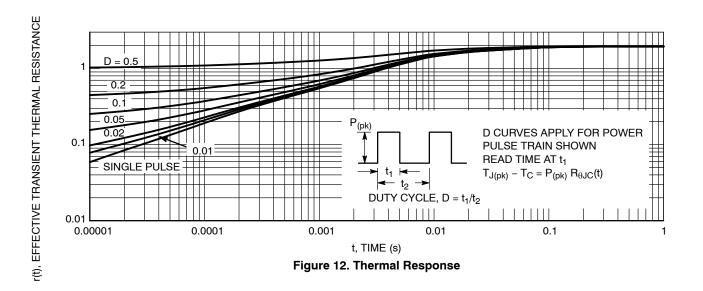


Variation vs. Gate Resistance

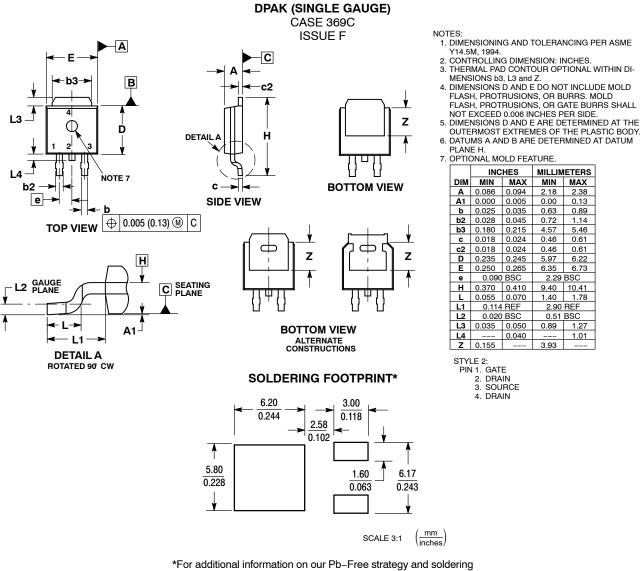




TYPICAL PERFORMANCE CURVES



PACKAGE DIMENSIONS



details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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